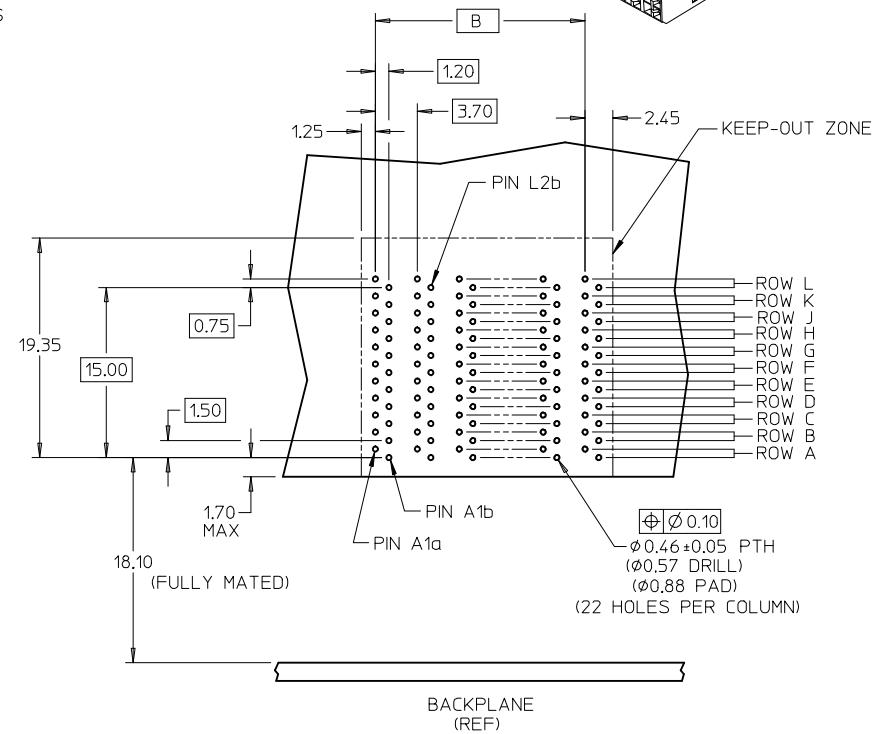
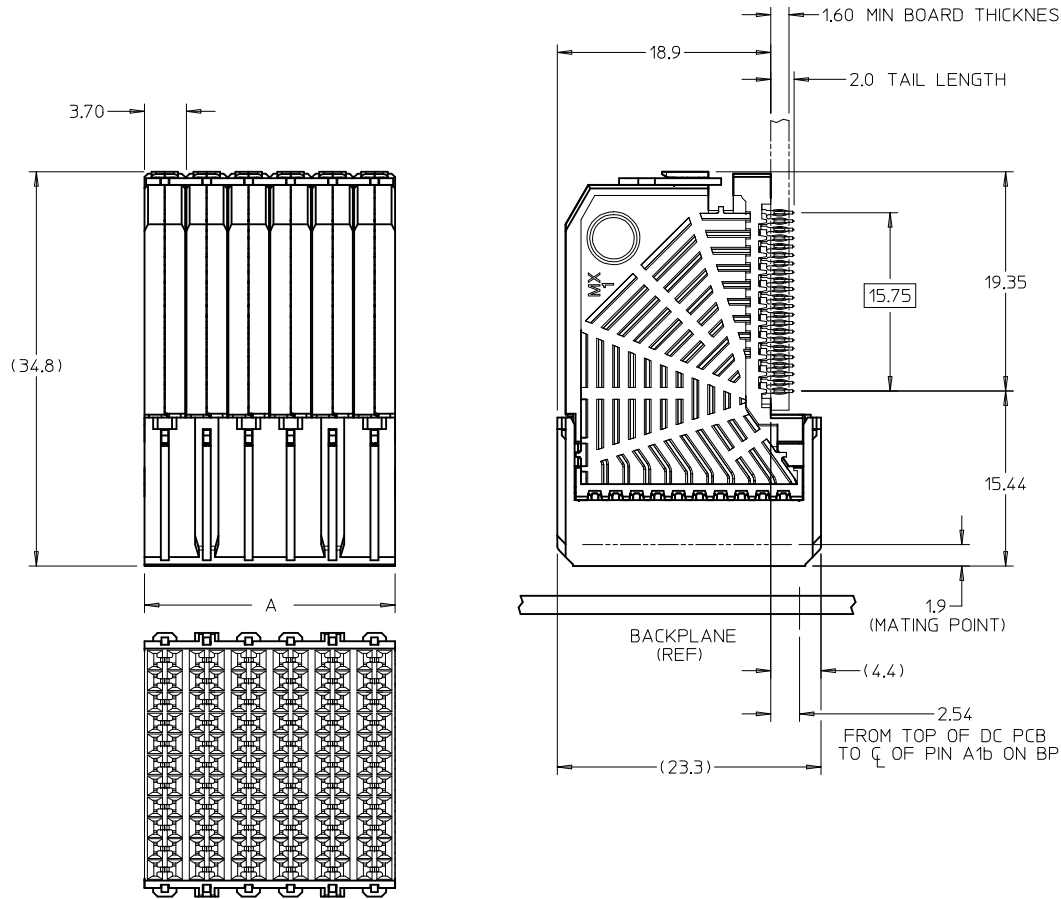
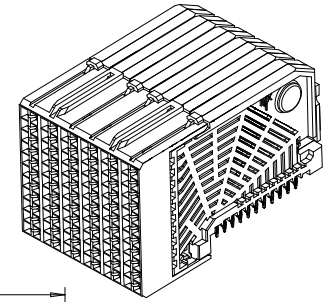


MATERIAL NUMBER	# OF COLUMNS	DIM "A" MAX	DIM "B"
75710-***5	5	18.50	14.80
75710-***6	6	22.20	18.50
75710-***8	8	29.60	25.90
75710-***0	10	37.00	33.30

MODULE TYPE -- TAIL PLATING TYPE
 UNGUIDED -- MATTE TIN (FORMERLY TIN/LEAD) = 0
 UNGUIDED -- MATTE TIN = 1

OF COLUMNS/PLATING
 05 = 5 COL 30 GOLD
 06 = 6 COL 30 GOLD
 08 = 8 COL 30 GOLD
 10 = 10 COL 30 GOLD
 55 = 5 COL 10 GOLD (MAPS)
 56 = 6 COL 10 GOLD (MAPS)
 58 = 8 COL 10 GOLD (MAPS)
 50 = 10 COL 10 GOLD (MAPS)



DAUGHTERCARD HOLE PATTERN
 (CONNECTOR SIDE)

NOTES:

1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP) GLASS-FILLED, UL94V-0
 TERMINALS - HIGH PERFORMANCE COPPER ALLOY
2. FINISH: SELECTIVE GOLD IN CONTACT AREA.
 SELECTIVE MATTE TIN ON PCB TAILS, NICKEL OVERALL.
3. REFER TO MOLEX PRODUCT SPEC PS-75710-999 FOR PERFORMANCE SPECIFICATIONS.
4. PRODUCT IS PACKAGED PER PK-70873-609.
5. THIS PART CONFORMS TO CLASS B REQUIREMENTS OF COSMETIC SPEC PS-45499-002.
6. MAPS (MOLEX ADVANCED PLATING SYSTEM)

LEAD FREE CON/MAFS EC NO: UCP2013-4121 DRAWN BY: JLAURX CHECKED BY: NMARTIN APPROVED BY: CBIXLER DATE: 2013/04/01 DATE: 2013/04/01 DATE: 2013/07/15	QUALITY SYMBOLS ▽=0 ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED) mm INCH 4 PLACES ± --- ± --- 3 PLACES ± --- ± --- 2 PLACES ± 0.13 ± --- 1 PLACE ± 0.25 ± --- 0 PLACE ± ± ANGULAR ±1/2° DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	DIMENSION STYLE MM ONLY DRAWN BY: JLAURX CHECKED BY: NMARTIN APPROVED BY: CBIXLER DATE: 09/01/2005 DATE: 09/01/2005 DATE: 09/01/2005	SCALE 3:1 TITLE I-TRAC DAUGHTERCARD 11 ROW SIGNAL MODULE UNGUIDED SALES DWG DOCUMENT NO. SD-75710-001	DESIGN UNITS METRIC THIRD ANGLE PROJECTION	SHEET NO. 1 OF 1